

SPECIFICATION

宏致電子股份有限公司

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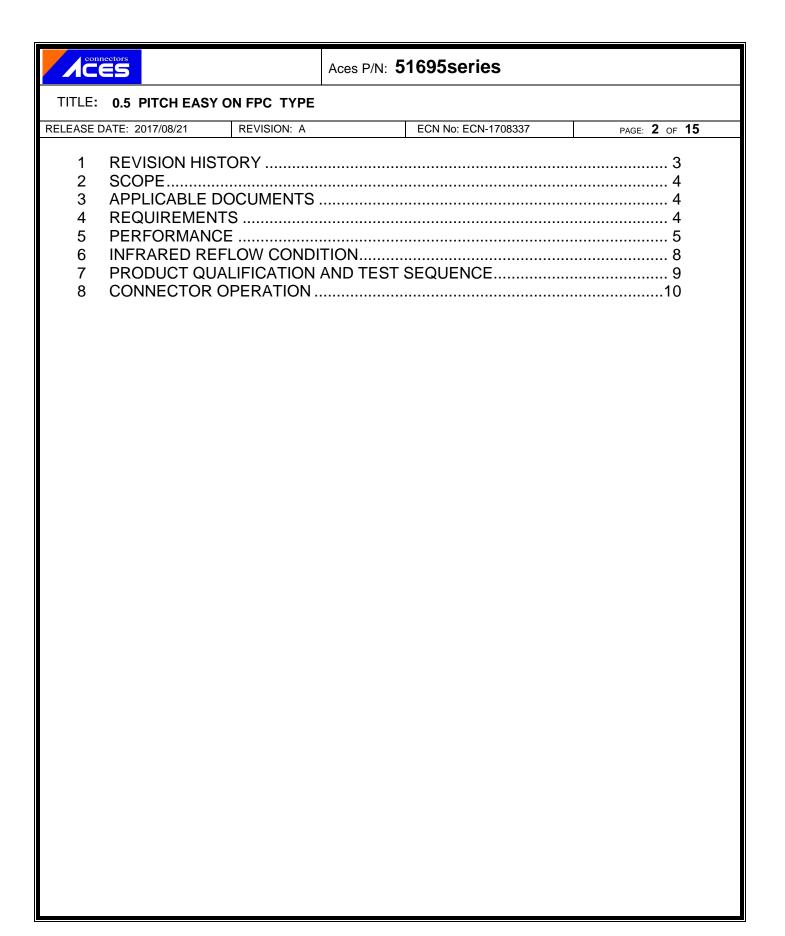
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SPEC. NO.:	PS-516	895-XXXXX-XXX	REVISION:	A
PRODUCT N	NAME:	0.5 mm PITCH EASY	ON FPC CONN.	
		SMT R/A B/C TYPE		
PRODUCT N	O:	51695 SERIES		

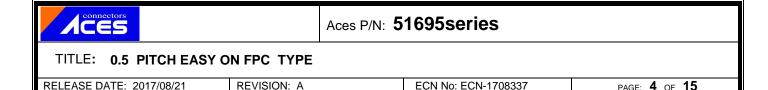
DATE: 2017/07/10	DATE: 2017/07/10	DATE: 2017/07/10
JAMESLEN.WANG	RYAN.LIU	K.HISATOMI
PREPARED:	CHECKED:	APPROVED:



CES Connectors	Aces P/N: 51695series				
TITLE: 0.5 PITCH EASY O	N FPC TYPE				
RELEASE DATE: 2017/08/21	REVISION: A		FCN No: FCN-1708337	DACE: 3 OF 15	

1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date
0	ECN-1707124	MODIFY ENVIRONMENTAL REQUIREMENT	JAMESLEN	2017.07.10
Α	ECN-1708337	ADD Salt Spray Gold plating ≥5 u"	JAMESLEN	2017.08.21



SCOPE

This specification covers performance, tests and quality requirements for 0.5 mm Pitch Easy On FPC CONN. SMT R/A B/C TYPE.

ACES Part/Number: 51695 SERIES

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

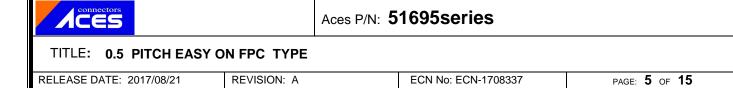
REQUIREMENTS

- 4.1 Design and Construction
 - Product shall be of design, construction and physical dimensions specified on 4.1.1 applicable product drawing.
 - All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101. 4.1.2
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)

(a) Contact Area: Refer to the drawing.

- (b) Under plate: Refer to the drawing.
- (c) Solder area: Refer to the drawing.
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Actuator: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.4 Fitting Nail: Copper Alloy, Finish: Refer to the drawing.
- 4.3 Ratings
 - 4.3.1 Working voltage less than 36 volts AC (per pin)
 - 4.3.2 Voltage: 50 Volts AC (per pin)
 - 4.3.3 Current: 0.5 Amperes (per pin)
 - 4.3.4 Operating Temperature : -40°C to +85°C

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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard					
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	per applicable quality inspection					
	plan.						
Item Requirement Standard							
Low Level Contact Resistance	100 m Ω Max. per contact	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)					
Insulation Resistance	1000 M Ω Min.	Unmated connectors, apply 100 V DC between adjacent terminals. (EIA-364-21)					
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	200 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)					
Temperature rise	30°ℂ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70, METHOD1,CONDITION1)					



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MECHANICAL						
Item	Requirement	Standard				
Durability	10 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)				
Terminal /Housing Retention Force	50 gf MIN.	Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.				
Fitting Nail /Housing Retention Force	50 gf MIN.	Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.				
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)				
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)				

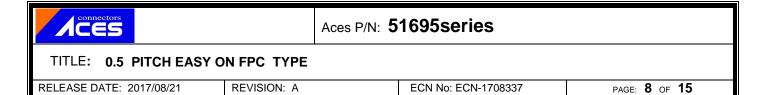


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ENVIRONMENTAL						
Item	Requirement	Standard				
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free) Appearance: No damage	Pre Heat: 150°C~180°C, 60~120sec. Heat: 230°C Min., 40sec Min. Peak Temp.: 260°C Max, 10sec Max.				
Thermal Shock	Appearance :No damage Contact Resistance: $100m\Omega$ Max. Insulation Resistance: $1000M\Omega$ Min. Dielectric Withstanding Voltage: No breakdown	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)				
Humidity	Appearance :No damage Contact Resistance: $100m\Omega$ Max. Insulation Resistance: $1000M\Omega$ Min. Dielectric Withstanding Voltage: No breakdown	Mated Connector 40°C, 90∼95% RH, 96 hours. (EIA-364-31,Condition A, Method II)				
Temperature life	Appearance :No damage Contact Resistance: $100m\Omega$ Max. Insulation Resistance: $1000M\Omega$ Min. Dielectric Withstanding Voltage: No breakdown	Subject mated connectors to temperature life at 85°C for 96 hours. (EIA-364-17, Test condition A)				
Salt Spray (Only For Gold Plating)	Appearance :No damage	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 3 u" for 48 hours (III) Gold plating ≥ 5 u" for 96 hours (EIA-364-26)				
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)				
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.				

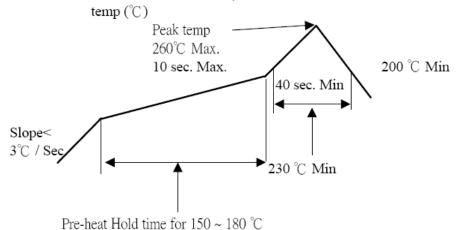
Note. Flowing Mixed Gas shell be conduct by customer request.



6 INFRARED REFLOW CONDITION

is 60 ~ 120 sec.

TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)



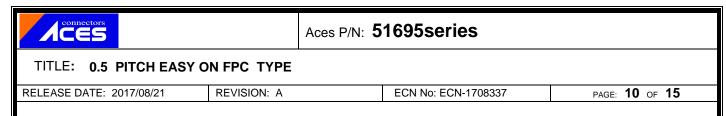


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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group										
Test or Examination		2	3	4	5	6	7	8	9	10	11
					Test	Sequ	ence				
Examination of Product				1 . 7	1、6	1 \ 4		1		1 \ 4	
Low Level Contact Resistance		1 \ 3	1 \ 4	2、10	2 ` 9	2 ` 5				3	
Insulation Resistance				3、9	3、8						
Dielectric Withstanding Voltage				4 \ 8	4 \ 7						
Temperature rise	1										
Durability		3									
Vibration			2								
Shock (Mechanical)			3								
Thermal Shock				5							
Humidity				6							
Temperature life					5						
Salt Spray(Only For Gold Plating)						3					
Solder ability							1				
Terminal / Housing Retention Force									1		
Fitting Nail /Housing Retention Force											1
Resistance to Soldering Heat										2	
Hand Soldering Temperature Resistance								2			
Sample Size	2	4	4	4	4	4	2	4	4	4	4

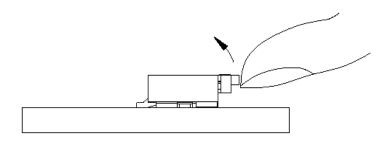


8 CONNECTOR OPERATION

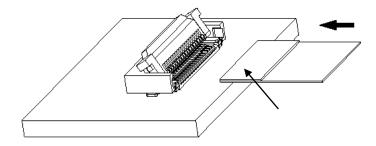
OPERATION

FPC insertion procedure. Connector installed on the board.

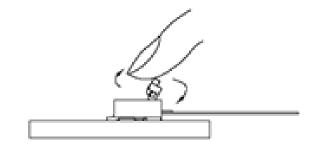
1)Lift up the actuator. Use thumb or index finger.

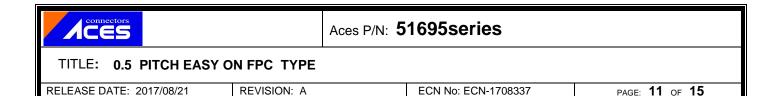


2) Fully insert the FPC in the connector parallel to mounting surface, with the exposed conductive traces facing down.



3) Rotate down the actuator until firmly closed. It is critical that the inserted FPC is not moved and remains fully inserted.



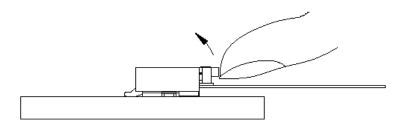


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FPC/FFC Removal

- 1) Lift up the actuator.
- 2) Carefully remove the FPC/FFC.



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PRECAUTIONS

PC board flexing

1)SPC board connector mounting area

The connectors are straight within 0.1 mm max.

Make sure that the PC board connector mounting area flatness can accept the connector terminals without causing any failure of the solder joints.

2)SHandling before mounting on PCB

Insertion of the FPC or operation of the actuator prior to mounting on the PCB is NOT RECOMMENDED.

3)SPC Board handling

Exercise caution when handling boards with the connectors installed. Do not apply any forces affecting soldered joints.

Lock release

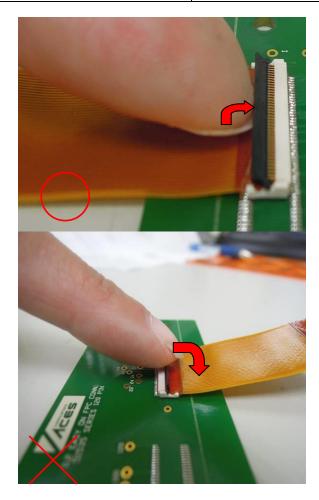
Carefully rotate the actuator up to 90°, lifting it at the center.

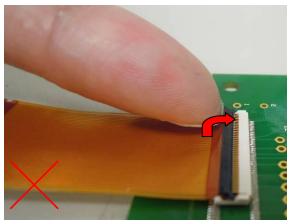
The actuator opens by rotating it in the direction OPPOSITE to the direction of the insertion of the FPC. DO NOT attempt to open it from the same side as the insertion of the FPC.



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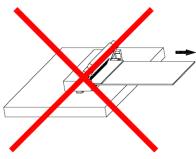




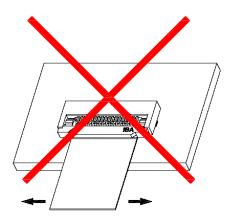
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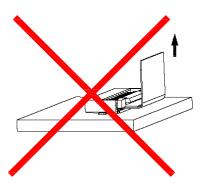
1) Do when you pull out mating FPC/FFC with the Actuator opened completely. Confirm whether to Have adhered to the terminal contact part before FPC/FFC is mated with the connector housing when the opening of the actuator is the un-complete and FPC/FFC is pulled out.

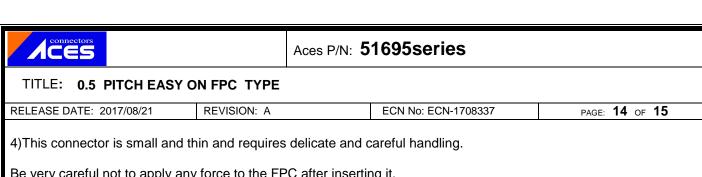


2) Do not add the load mating FPC/FFC with connector housing.



3) Due to the structure of the connectors, they do not have string resistance to upward pulling; therefore, support the FPC/FFC when a pulling force is applied to it.





Be very careful not to apply any force to the FPC after inserting it.

Otherwise, the connector may become unlocked or the FPC may break.

Fix the FPC, in particular, when loads are applied to it continuously.

Design the FPC layout with care not to bend it sharply near the insertion opening.

